Docket No.: 27-006 **PATENT**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Virgil Cotoco Ararao, et al.

Confirmation No.:

6546

Serial No.:

10/721,916

: Art Unit:

2893

Filed:

11/24/2003

: Examiner:

Thanh T. Nguyen

For:

FABRICATION METHOD FOR SEMICONDUCTOR PACKAGE HEAT

SPREADERS

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COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

DOES NOT AFFECT PATENT TERM ADJUSTMENT Under 37 CFR 1.704(c)(10)

Sir/Madam:

The following Comments are submitted in response to the Notice of Allowability dated April 7, 2009. Applicants respectfully request no reduction of the Patent Term Adjustment in accordance with Clarification of 37 CFR 1.704(c)(10) – "Reduction of Patent Term Adjustment for Certain Types of Papers Filed After a Notice of Allowance has been Mailed", 1247 Official Gazette Patent Office 111 (June 26, 2001), which states:

"The submission of the following paper after a Notice of Allowance is <u>not</u> considered a failure to engage in reasonable efforts to conclude processing or examination for an application: ...(6) <u>a response to the examiner's reasons for allowance</u> or a request to correct an error or omission in the 'Notice of Allowance' or 'Notice of Allowability'... [underlining and deletion for clarity]

COMMENTS

Concerning the Examiner's statement of reasons for allowance, it is respectfully submitted that claims 1-10 and 21-30 are allowable because they claim a <u>combination</u>, which includes, *inter alia*, concepts related to those addressed by the Examiner.

Respectfully submitted,

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